

#### SURFACE MOUNT LED TAPE AND REEL



### LSBK9553S/TR1

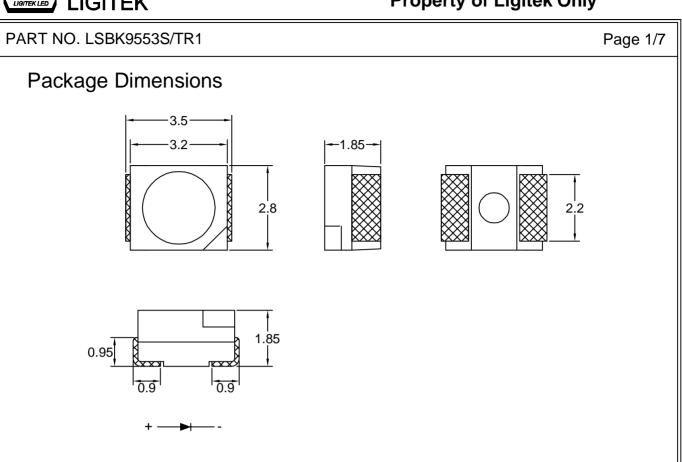
### **DATA SHEET**

DOC. NO: QW0905-LSBK9553S/TR1

REV. : B

DATE : 10 - Jul. - 2007

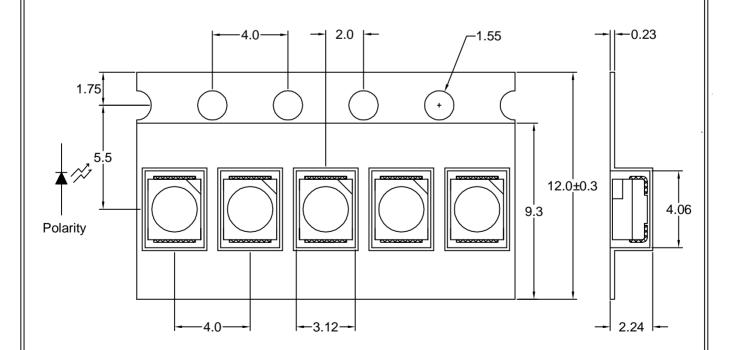




Note : 1.All dimension are in millimeter tolerance is  $\pm 0.2$ mm unless otherwise noted.

2. Specifications are subject to change without notice.

### Carrier Type Dimensions



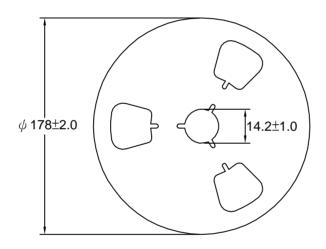
Note : The tolerances unless mentioned is  $\pm 0.2$ mm,Angle  $\pm 0.5$ . Unit=mm.

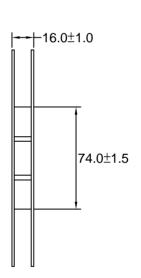


PART NO. LSBK9553S/TR1

Page 2/7

### **Reel Dimensions**





Part No.	Description	Quantity/Reel		
LSBK9553S/TR1	12.0mm tape,7"reel	1500 devices		



PART NO. LSBK9553S/TR1

Page 3/7

### Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Ratings	UNIT	
Farameter	Symbol	SBKS		
Forward Current	lF	30	mA	
Peak Forward Current Duty 1/10@10KHz	IFP	100	mA	
Power Dissipation	PD	120	mW	
Reverse Current @5V	lr	50	$\mu$ A	
Electrostatic Discharge( * )	ESD	500	V	
Operating Temperature	Topr	-20 ~ +80	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-30 ~ +100	$^{\circ}\!\mathbb{C}$	

<sup>★</sup> Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.

### Typical Electrical & Optical Characteristics (Ta=25 °C)

PART NO	MATERIAL	COLOR		Dominant wave length $\lambda$ Dnm	Spectral halfwidth $\triangle \lambda$ nm	Forward voltage @20mA(V)		Luminous intensity @20mA(mcd)		Viewing angle 2 θ 1/2 (deg)
		Emitted	Lens			Тур.	Max.	Min.	Тур.	
LSBK9553S/TR1	InGaN/SiC	Blue	Water Clear	475	26	3.5	4.2	50	125	120

Note: 1. The forward voltage data did not including  $\pm 0.1 \text{V}$  testing tolerance.

<sup>2.</sup> The luminous intensity data did not including  $\pm 15\%$  testing tolerance.

PART NO. LSBK9553S/TR1

Page 4/7

### Typical Electro-Optical Characteristics Curve

**SBK-S CHIP** 

Fig.1 Forward current vs. Forward Voltage

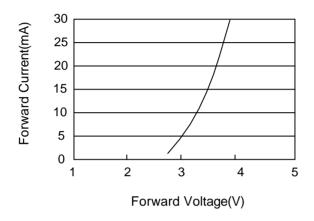


Fig.2 Relative Intensity vs. Forward Current

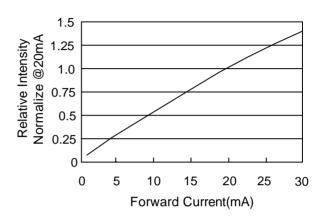


Fig.3 Forward Current vs. Temperature

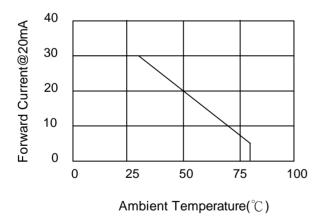
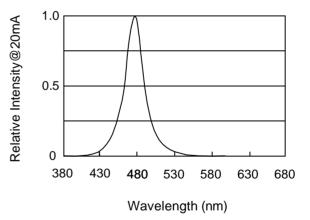


Fig.4 Relative Intensity vs. Wavelength





#### PART NO. LSBK9553S/TR1

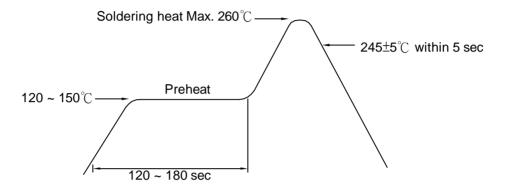
Page 5/7

#### Recommended Soldering Conditions

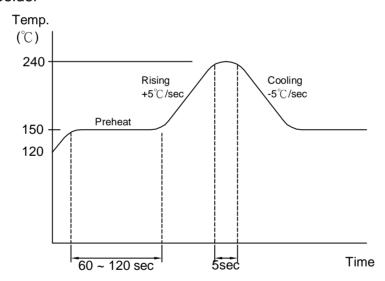
#### 1. Hand Solder

Basic spec is  $\leq 280^{\circ}$ C 3 sec one time only.

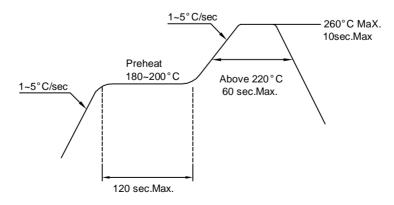
#### 2. Wave Solder



#### 3. LEAD Reflow Solder



#### 4. PB-Free Reflow Solder



Note: 1. Wave solder and reflow soldering should not be made more than one time.

2. You can just only select one of the soldering conditions as above.



#### PART NO. LSBK9553S/TR1

Page 6/7

#### Precautions For Use:

#### Storage time:

- 1.The operation of Temperatures and RH are : 5 °C ~35 °C ,RH<60%.
- 2.Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year(from production date).
- 3.If opened more than one week in an atmosphere 5  $^{\circ}$ C ~ 35 $^{\circ}$ C ,RH<60%, they should be treated at 60  $^{\circ}$ C±5  $^{\circ}$ C fo r 15hrs.

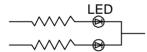
#### **Drive Method:**

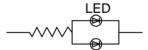
LED is a current operated device, and therefore, requirer some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forwrd current should not be allowed to change by more than 40 % of its desired value.

Circuit model A







- (A) Recommended circuit.
- (B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

#### ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.



PART NO. LSBK9553S/TR1 Page 7/7

Reliability Test:

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	MIL-STD-750D: 1026 MIL-STD-883D: 1005 JIS C 7021: B-1
	High Temperature Storage Test	1.Ta=105 ℃±5℃ 2.t=1000 hrs (-24hrs, +72hrs)	MIL-STD-883D:1008 JIS C 7021: B-10
	Low Temperature Storage Test	1.Ta=-40 °C ±5 °C 2.t=1000 hrs (-24hrs, +72hrs)	JIS C 7021: B-12
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=65 ℃±5 ℃ 3.RH=90 %~95 % 4.t=1000hrs ±2hrs	MIL-STD-202F:103B JIS C 7021: B-11
	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105 °C±5 °C & -40 °C±5 °C (10min) (10min) 3.total 10 cycles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1011
Environmental Test	Solderability Test	1.T.Sol=235 $^{\circ}$ C ±5 $^{\circ}$ C 2.Immersion time 2 ±0.5sec 3.Immersion rate 25 ±2.5mm/sec 4.Immersion rate 25 ±2.5mm/sec 5.Coverage ≥95% of the dipped surface	MIL-STD-202F: 208D MIL-STD-750D: 2026 MIL-STD-883D: 2003 IEC 68 Part 2-20 JIS C 7021: A-2
	Temperature Cycling	$1.105^{\circ}$ C ~ $25^{\circ}$ C ~ $55^{\circ}$ C ~ $25^{\circ}$ C 30mins 5mins 30mins 5mins 2.10 Cyeles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1010 JIS C 7021: A-4
	Solderability Test	Ramp-up rate(183 $^{\circ}$ C to Peak) +3 $^{\circ}$ C second max Temp. maintain at 125( $\pm 25$ ) $^{\circ}$ C 120 seconds max Temp. maintain above 183 $^{\circ}$ C 60-150 seconds Peak temperature range 235 $^{\circ}$ C+5-0 $^{\circ}$ C Time within 5 $^{\circ}$ C of actual Peak Temperature(tp) 10-30 seconds Ramp-down rate +6 $^{\circ}$ C/second max	MIL-STD-750D:2031.2 J-STD-020